CGS74B303 Octal Divide-by-2 Skew Clock Driver

# CGS74B303 Octal Divide-by-2 Skew Clock Driver

#### **General Description**

These minimum skew clock drivers are designed for high frequency Clock Generation and Support (CGS) applications. These devices are ideal for duty cycle recovery applications with internal frequency divide-by-2 circuitry. The devices guarantee minimum skew across the outputs of a given device. Skew parameters are also provided as a means to measure duty cycle requirements as those found in high speed clocking systems.

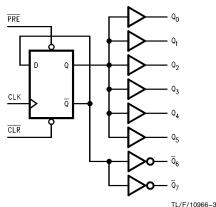
#### **Functional Description**

The CGS74B303 contains eight flip-flops designed to have low skew between outputs. The eight outputs (six in-phase with CLK and two out-of-phase) toggle on successive CLK pulses. PRE and CLR inputs are provided to set Q and Q outputs high or low independent of CLK pin.

#### **Features**

- Clock Generation and Support (CGS) Devices ideal for high frequency signal generation or clock distribution applications
- Fabricated on National's Advanced Bipolar FAST™ LSI process
- 1 ns pin-to-pin output skew
- Specification for transition skew to meet duty cycle requirements
- Current sourcing 24 mA and current sinking of 48 mA
- Low dynamic power consumption above 20 MHz
- Guaranteed 4 kV ESD protection

## **Logic Diagram**



## **Connection Diagram**

#### Pin Assignment SOIC (M) $Q_1$ $Q_3$ $Q_0$ GND -- CLR GND $v_{cc}$ GND -• v<sub>cc</sub> CLK Q, 0-PRE

TL/F/10966-1

## **Pin Description**

Pin Names	Description
CLK	Clock Input
Q <sub>0</sub> -Q <sub>7</sub>	Outputs
PRE	Preset
CLR	Clear

#### **Truth Table**

Inputs			Outputs		
CLR	PRE	CLK	Q <sub>0</sub> -Q <sub>5</sub>	$\overline{Q}_6$ – $\overline{Q}_7$	
L	Н	Х	L	Н	
Н	L	Χ	Н	L	
L	L	Χ	L*	L*	
Н	Н	<b>1</b>	Q	Q	
Н	Н	L	Q	Q	

<sup>\*</sup>This state will not persist when CLR/PRE returns to high.

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### **Absolute Maximum Ratings (Note)**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V<sub>CC</sub>) 7.0V Input Voltage (V<sub>I</sub>) 7.0V Operating Free Air Temperature  $0^{\circ}$ C to  $+70^{\circ}$ C Storage Temperature Range -65°C to +150°C

Typical  $\theta_{JA}$ Airflow (LFM) 0 225 500

Jedec SOIC (M) Package 118 96 86 °C/W

## **Recommended Operating Conditions**

Supply Voltage (V<sub>CC</sub>) 4.5V to 5.5V Input Rise and Fall Times 2 ns max (0.8V to 2.0V)

0°C to 70°C Free Air Operating Temperature (T<sub>A</sub>)

NOTE: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the DC and AC Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The Recommended Operating Conditions will define the conditions for actual device operation.

#### **DC Electrical Characteristics**

Over recommended operating conditions unless specified otherwise. All typical values are measured at  $V_{CC}=5V, T_A=25^{\circ}C.$ 

Symbol	Parameter	Cond	ditions	Min	Тур	Max	Unit	
V <sub>IK</sub>	Input Clamp Voltage	$V_{CC} = 4.5V, I_I$	= -18  mA			-1.2	V	
V <sub>IH</sub>	Minimum Input High Level Voltage			2.0			V	
$V_{IL}$	Maximum Input Low Level Voltage					0.8	V	
V <sub>OH</sub>	High Level Output Voltage	$I_{OH} = -2 \text{ mA},$	$V_{CC} = 4.5V$	V <sub>CC</sub> – 2			V	
		$I_{OH} = -24 \text{ m/s}$	$A, V_{CC} = 4.5V$	2.0				
V <sub>OL</sub>	Low Level Output Voltage	$V_{CC} = 4.5V, I_{C}$	<sub>DL</sub> = 48 mA		0.35	0.5	V	
I <sub>I</sub>	Input Current @ Max Input Voltage	$V_{CC} = 5.5V, V$	1 <sub>IH</sub> = 7V			0.1	m A	
I <sub>IH</sub>	High Level Input Current	$V_{CC} = 5.5V, V$	IH = 2.7V			20	μΑ	
I <sub>IL</sub>	Low Level Input Current	$V_{CC} = 5.5V, V$	<sub>IL</sub> = 0.4V		-0.1	-0.50	mA	
lo	Output Drive Current	$V_{CC} = 5.5V, V$	O = 2.25V	-50		-150	mA	
Icc	Supply Current	V <sub>CC</sub> = 5.5V	Outputs High		27	60	mA	
			Outputs Low		45	60	mA	
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = 5V			5		pF	

## **AC Electrical Characteristics**

Over recommended operating conditions unless specified otherwise. All typical values are measured at  $V_{CC}=5V$ ,  $T_A=25^{\circ}C$ .

Symbol	Parameter	$egin{array}{lll} V_{CC} = 4.5 V \ to 5.5 V \\ T_A = 0^{\circ} C \ to + 70^{\circ} C \\ C_L = 0 \ pF - 50 \ pF \\ R_L = 500 \Omega \end{array}$			Units
		Min	Тур	Max	
f <sub>MAX</sub>	Maximum Input Frequency (Note 2)	110			MHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay CLKn to O <sub>n</sub> (Note 2)	4		8.5	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay PRE/CLR	4		11	ns
t <sub>SU</sub>	Set Up Time before CLK	5			ns
t <sub>W</sub>	CLK HI CLK LO CLR/PRE	4 4 4			ns

#### **Extended AC Electrical Characteristics**

Over recommended operating conditions unless specified otherwise. All typical values are measured at  $V_{CC}=5V, T_A=25^{\circ}C$ .

Symbol	Parameter	$\begin{array}{c} V_{CC} = 4.5V \text{ to } 5.5V \\ T_A = 0^{\circ}\text{C to } + 70^{\circ}\text{C} \\ C_L = 0 \text{ pF-}50 \text{ pF} \\ R_L = 500\Omega \end{array}$			Units
		Min	Тур	Max	
t <sub>OSHL</sub> Q	Maximum Skew Common Edge Output-to-Output Variation (Notes 1, 2)		0.5	1.0	ns
<sup>t</sup> OSLH Q	Maximum Skew Common Edge Output-to-Output Variation (Notes 1, 2)		0.5	1.0	ns
<sup>t</sup> OSHL Q	Maximum Skew Common Edge Output-to-Output Variation (Notes 1, 2)		0.3	0.75	ns
<sup>t</sup> oslH Q	Maximum Skew Common Edge Output-to-Output Variation (Notes 1, 2)		0.3	0.75	ns
<sup>t</sup> oslh/HL Q,\alpha	Maximum Skew Common Edge Output-to-Output Variation (Notes 1, 2)		1.0	1.6	ns
<sup>t</sup> PS Q	Maximum Skew Pin (Signal) Transition Variation (Notes 1, 2)			1.0	ns
t <sub>rise</sub> , t <sub>fall</sub>	Rise/Fall Time (from 0.8V/2.0V to 2.0V/0.8V) 0 pF-30 pF Loads		1.1 0.9	2.0 2.0	ns

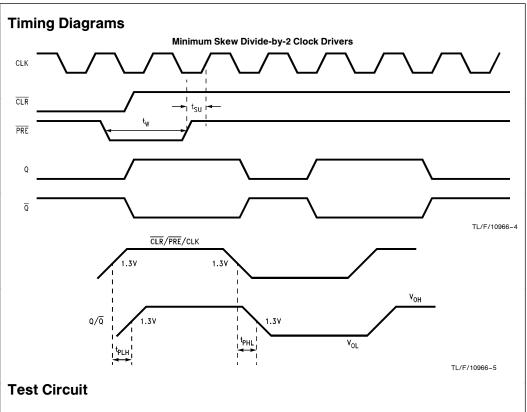
Note 1: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH to LOW (t<sub>OSHL</sub>) or LOW to HIGH (t<sub>OSLH</sub>) or in opposite directions both HL and LH (t<sub>OST</sub>). Parameters t<sub>OST</sub> and t<sub>PS</sub> guaranteed by design.

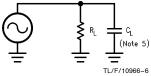
Note 2: This device is sensitive to noise due to the large transient currents which occur during multiple switching of the eight outptus. V<sub>CC</sub> by-pass capacitor(s), chip types, must be placed as closely as possible to the V<sub>CC</sub> pin.

Note 3: Refer to Minimum Skew Parameters Measurement Information Chart for definitions of each skew specification.

Note 4: All input pulses are from 3.5V to 0.3V with rise and fall times of 2.0 ns.

Note 5: Load capacitance includes the test jig.



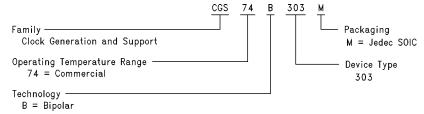


 $R_{\text{L}}$  is  $500\Omega$ 

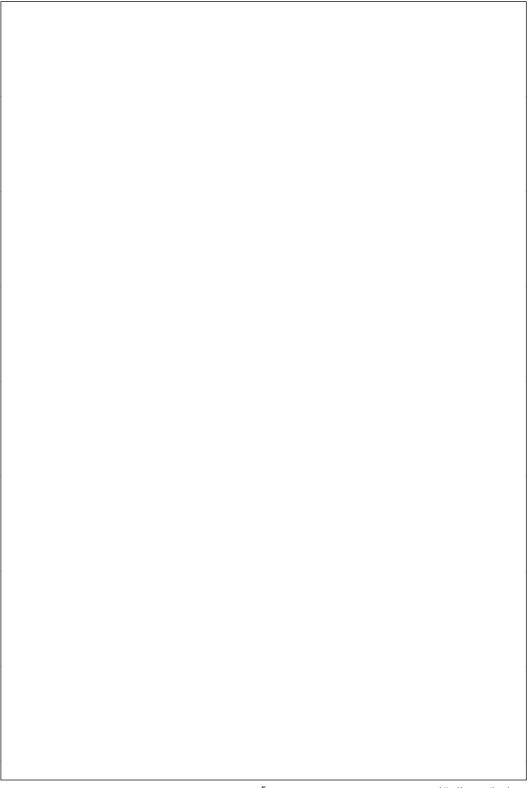
 $C_L$  is 50 pF for all prop delays and skew measurements.  $C_L$  is 30 pF for  $t_{\text{rise}}$  and  $t_{\text{fall}}$  measurements.

## **Ordering Information**

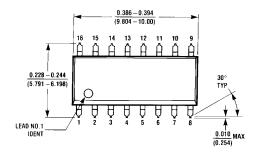
Contact NSC Marketing for specific date of availability

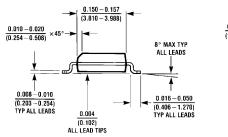


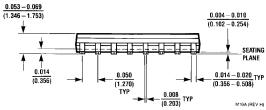
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## Physical Dimensions inches (millimeters) unless otherwise noted







16-Lead Small Outline Integrated Circuit (S) NS Package Number M16A

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